

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Myoung Won Suh</td><td>08/11/2006</td></tr><tr><td>Dae Hyeong Kim</td><td>08/11/2006</td></tr></tbody></table>	Name	Execution Date	Myoung Won Suh	08/11/2006	Dae Hyeong Kim	08/11/2006					
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RECEIVING PARTY DATA											
<table border="1"><tr><td>Name:</td><td>K. C. Tech Co., Ltd</td></tr><tr><td>Street Address:</td><td>268-1, Geruk-Ri, Miyang-Myeon</td></tr><tr><td>City:</td><td>Anseong-Si, Gyeonggi-Do</td></tr><tr><td>State/Country:</td><td>KOREA, REPUBLIC OF</td></tr><tr><td>Postal Code:</td><td>456-840</td></tr></table>	Name:	K. C. Tech Co., Ltd	Street Address:	268-1, Geruk-Ri, Miyang-Myeon	City:	Anseong-Si, Gyeonggi-Do	State/Country:	KOREA, REPUBLIC OF	Postal Code:	456-840	
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
Fax Number: (202)261-0548 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone: 2024293000											
Email: sethwatkins@step toe.com											
Correspondent Name: Steptoe & Johnson LLP											
Address Line 1: 1330 Connecticut Avenue, NW											
Address Line 4: Washington, DISTRICT OF COLUMBIA 20036-1795											
ATTORNEY DOCKET NUMBER:	16003.0002										
NAME OF SUBMITTER:	Seth A. Watkins										
Total Attachments: 2 source=KCTech#page1.tif source=KCTech#page2.tif											

CH \$40.00 11421965

ASSIGNMENT

WHEREAS, We,

Myoung Won SUH, a citizen of the Republic of Korea with an address at **704-1001, Sangnok Apt., Pungdeokcheon 2-Dong, Yongin-Si, Gyeonggi-Do, 448-990**, Republic of Korea and **Dae Hyeong KIM**, a citizen of the Republic of Korea with an address at **752-14, Yeoksam-Dong, Gangnam-Gu, Seoul, 135-925**, Republic of Korea,

ASSIGNORS, are the inventors of the invention in **CMP SLURRY, PREPARATION METHOD THEREOF AND METHOD OF POLISHING SUBSTRATE USING THE SAME** for which we have executed an application for a Patent of the United States

- ☒ which is identified by Steptoe & Johnson LLP docket no. 16003.0002
- ☒ which was filed in the United States on June 2, 2006 as application no. 11/421,965.

WHEREAS, **K. C. TECH CO., LTD.**, a company of the Republic of Korea having a place of business at 268-1, Geruk-Ri, Miyang-Myeon, Anseong-Si, Gyeonggi-Do, 456-840, Republic of Korea, ASSIGNEE, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith;

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention.

IN WITNESS WHEREOF, the undersigned inventors have affixed their signatures.

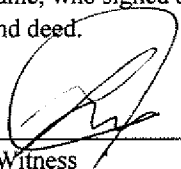
Assignment for
application no. 11/421,965

08/11/2006
Date


Myung Won Suh
Myoung Won SUH

On this 10th day of August, 2006, before me appeared **Myoung Won SUH**, to me known and known to me to be the person of that name, who signed and sealed the foregoing instrument, and acknowledged the same to be his free act and deed.

08/11/2006
Date


Witness

08/11/2006
Date


Dae Hyeong KIM

On this 10th day of August, 2006, before me appeared **Dae Hyeong KIM**, to me known and known to me to be the person of that name, who signed and sealed the foregoing instrument, and acknowledged the same to be his free act and deed.

08/11/2006
Date


Witness